

Product data sheet

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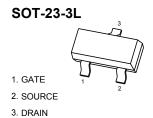


FEATURE

- High dense cell design for extremely low R_{DS(ON)}.
- Exceptional on-resistance and maximum DC current capability

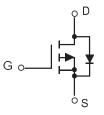
APPLICATION

- Load/Power Switching
- Interfacing Switching



Equivalent Circuit

V _{(BR)DSS}	R _{DS(on)} MAX	I _D
-30 V	65mΩ@-10V	
	75mΩ@-4.5V	-4.2A
	90mΩ@-2.5V	



Maximum ratings (T_a=25℃ unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V _{DS}	-30	V
Gate-Source Voltage	V _{GS}	±12	V
Continuous Drain Current	ID	-4.2	A
Power Dissipation	PD	350	mW
Thermal Resistance from Junction to Ambient (t<5s)	R _{0JA}	357	°C/W
Junction Temperature	TJ	150	°C
Storage Temperature	T _{STG}	-55~+150	°C



MOSFET ELECTRICAL CHARACTERISTICS

T_a=25 $^\circ\!\!C$ unless otherwise specified

Parameter	Symbol	Test Condition	Min	Тур	Мах	Unit
Off characteristics						
Drain-source breakdown voltage	V(BR)DSS	Vgs = 0V, Id =-250µA	-30			V
Zero gate voltage drain current	IDSS	V _{DS} =-24V,V _{GS} = 0V			-1	μA
Gate-source leakage current	lgss	V _{GS} =±12V, V _{DS} = 0V			±100	nA
On characteristics			1			
.		Vgs =-10V, Id =-4.2A		50	65	mΩ
Drain-source on-resistance (note 1)	RDS(on)	V _{GS} =-4.5V, I _D =-4A		60	75	mΩ
		Vgs =-2.5V,ID=-1A		75	90	mΩ
Forward tranconductance (note 1)	g fs	VDS =-5V, ID =-5A	7			S
Gate threshold voltage	VGS(th)	VDS =VGS, ID =-250µA	-0.7	-0.9	-1.3	V
Dynamic characteristics (note 2)		1				1
Input capacitance	Ciss			954		pF
Output capacitance	Coss	VDs =-15V,VGs =0V,f =1MHz		115		pF
Reverse transfer capacitance	Crss			77		pF
Switching characteristics (note 2)						
Turn-on delay time	td(on)				6.3	ns
Turn-on rise time	tr	V _{GS} =-10V,V _{DS} =-15V,			3.2	ns
Turn-off delay time	td(off)	R _L =3.6Ω,R _{GEN} =6Ω			38.2	ns
Turn-off fall Time	tr	1			12	ns
Drain-source diode characteristic	s and maxi	mum ratings		1		
Diode forward voltage (note 1)	V _{SD}	I _S =-1A,V _{GS} =0V			-1	V

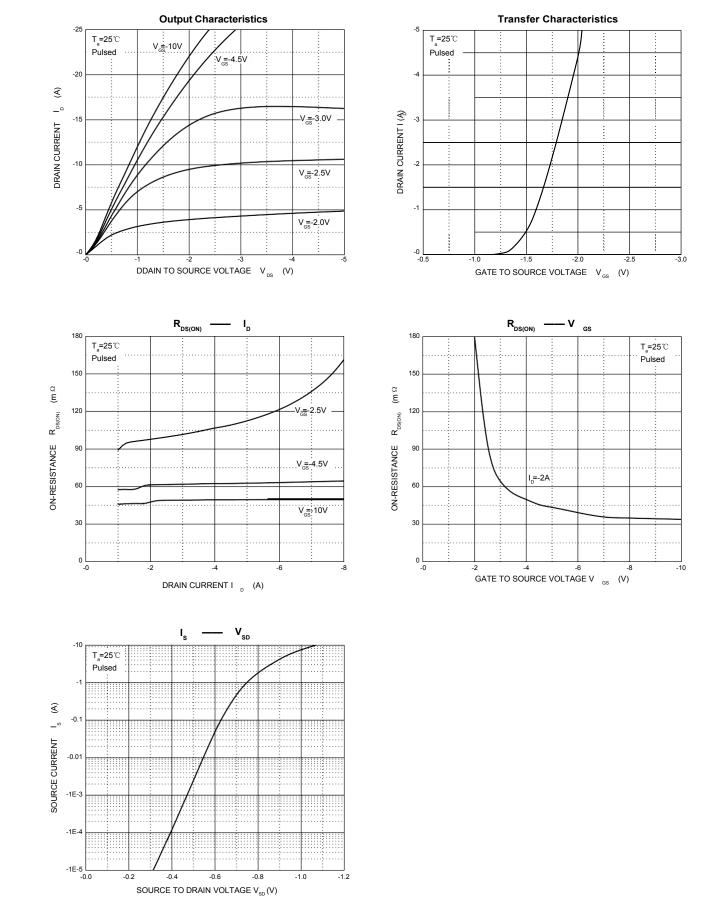
Note :

1. Pulse Test : Pulse width \leq 300µs, duty cycle \leq 2%.

2. These parameters have no way to verify.







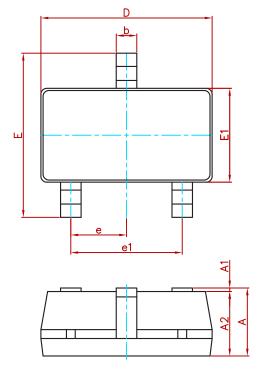
Typical Characteristics

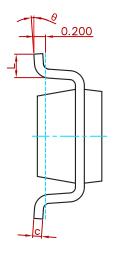


AO3401MI-MS HF 🧭

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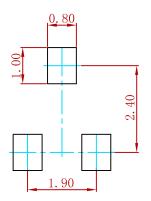
PACKAGE MECHANICAL DATA





Symbol	Dimensions In Millimeters		Dimensions In Inches		
Symbol	Min.	Max.	Min.	Max.	
А	1.050	1.250	0.041	0.049	
A1	0.000	0.100	0.000	0.004	
A2	1.050	1.150	0.041	0.045	
b	0.300	0.500	0.012	0.020	
С	0.100	0.200	0.004	0.008	
D	2.820	3.020	0.111	0.119	
E1	1.500	1.700	0.059	0.067	
E	2.650	2.950	0.104	0.116	
е	0.950(BSC)		0.037	(BSC)	
e1	1.800	2.000	0.071	0.079	
L	0.300	0.600	0.012	0.024	
θ	0°	8°	0°	8°	

Suggested Pad Layout



Note:

1.Controlling dimension: in millimeters.

2.General tolerance:± 0.05mm.

3. The pad layout is for reference purposes only.

REEL SPECIFICATION

P/N	PKG	QTY
AO3401MI-MS	SOT-23-3L	3000



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